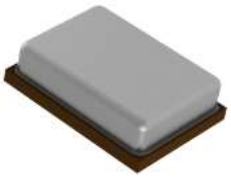
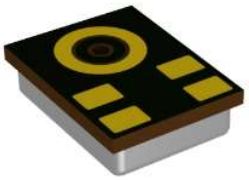
Description

The **GTA3562BA-2** is a small package, high SNR and analog output bottom port MEMS microphone, consists of a MEMS sensor and a low noise level ASIC.



Top View



Bottom View

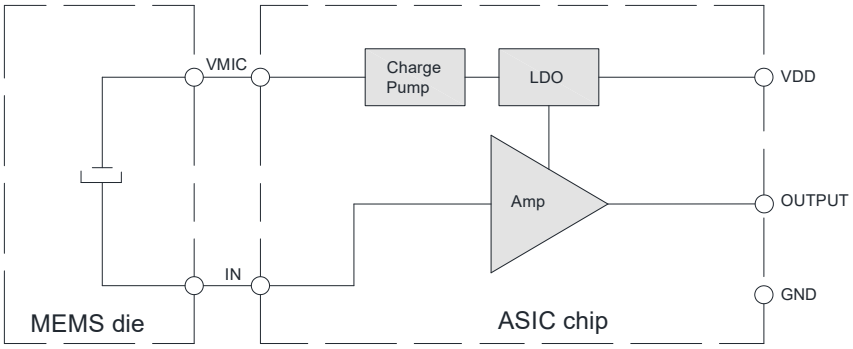


Fig. 1 Microphone block diagram

Key Features

- ✧ 3.5x2.65x0.98mm Bottom Port
- ✧ High SNR
- ✧ High AOP of 127dBSPL
- ✧ Narrow Sensitivity +/-1dB
- ✧ LFRO≤20Hz
- ✧ RF Shielded
- ✧ Compatible with Standard SMD Reflow Technology
- ✧ RoHS Compliance & Halogen Free

Typical Applications

- ✧ Mobilephones
- ✧ TWS Earphone
- ✧ Wireless Headsets
- ✧ Smart Speakers
- ✧ Wearable Electronics
- ✧ Portable Electronics
- ✧ Smart Home Electronics

Maximum Ratings

Stresses at the maximum ratings shown in Table 1 may cause permanent damage to the device. These are stress ratings only at which the device may not function when an operation at these or any other condition beyond those specified under “Electro-Acoustic Specifications”.

Table 1 Maximum Ratings

Parameter	Maximum Ratings	Unit
Supply voltage	4.2	V
Operation temperature range	-40~85	℃
Storage temperature range	-40~100	℃

Electro-Acoustic Specifications

Table 2 Electrical Specifications

Test condition: +25±2℃, 60%～70% RH, 86~106Kpa, Vdd=2V, no load, unless otherwise specified.

No.	Parameter	Symbol	Condition	Min.	Nom.	Max.	Unit
1	Sensitivity	S	f=1KHz, Pin=1Pa, 0dB=1V/Pa	-39	-38	-37	dB
2	Operating Voltage	V_{DD}		1.6	2	3.6	V
3	Directivity			Omni-directional			
4	Polarity		Sound pressure increase	Output voltage increase			
5	Sensitivity vs. Voltage	ΔS	Vs= 3.6V to 1.6V	<0.5			dB
6	Output Impedance	Z_{OUT}	f=1KHz			400	Ω
7	Current Consumption	I	3.6V to 1.6V		120	200	μA
8	S/N Ratio	S/N	20-5KHz Bandwidth, A-Weighted		68		dBA
			20-8KHz Bandwidth, A-Weighted		67		dBA
			20-20KHz Bandwidth, A-Weighted		66		dBA
9	Total Harmonic Distortion	THD	94dB SPL @1KHz		0.05	0.5	%
			122dBSPL @1KHz		1		
10	Acoustic Overload Point	AOP	THD 10%@1KHz		127		dBSPL
11	Power Supply Rejection	PSR	100mVpp Squarewave @217Hz,A-weighted		-104	-90	dB
12	Power Supply Rejection Ratio	PSRR	200mVpp Sinewave @1KHz	60	73		dB
13	DC output	VDC			0.85		V
14	Low Frequency Roll Off	LFRO				20	Hz
15	Output load	C_{load}				100	pF
		R_{load}		8			KΩ

Note：Frequency response, sensitivity and current consumption are tested by 100% on product line.

Performance Curves

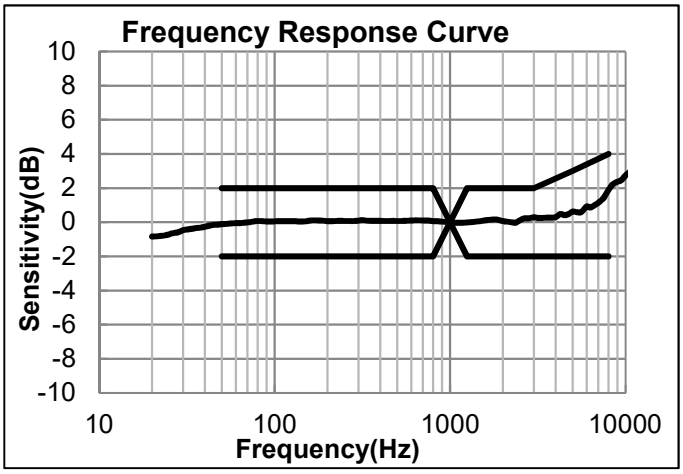


Fig.2 Frequency response curve normalized to 1KHz

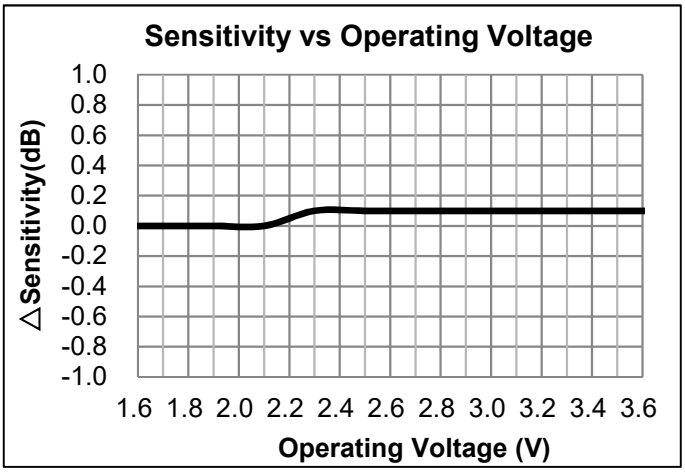


Fig. 3 Sensitivity vs Operating Voltage

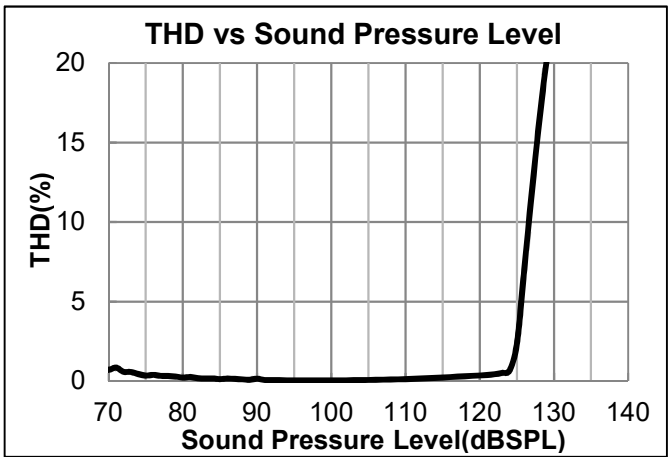


Fig. 4 Typical THD vs Sound Pressure Level

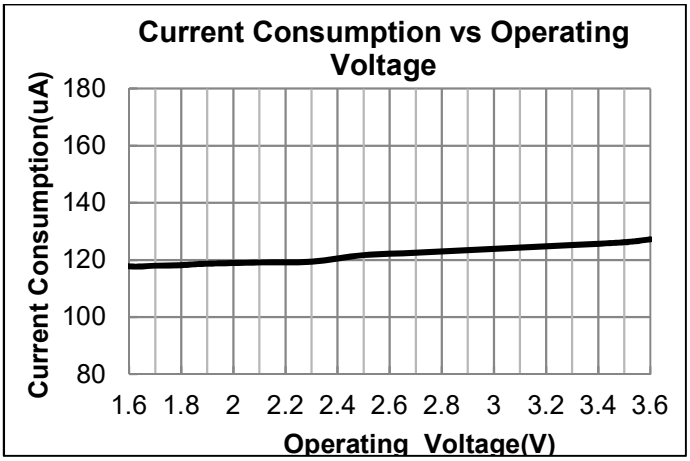


Fig. 5 Typical Current vs Operating Voltage

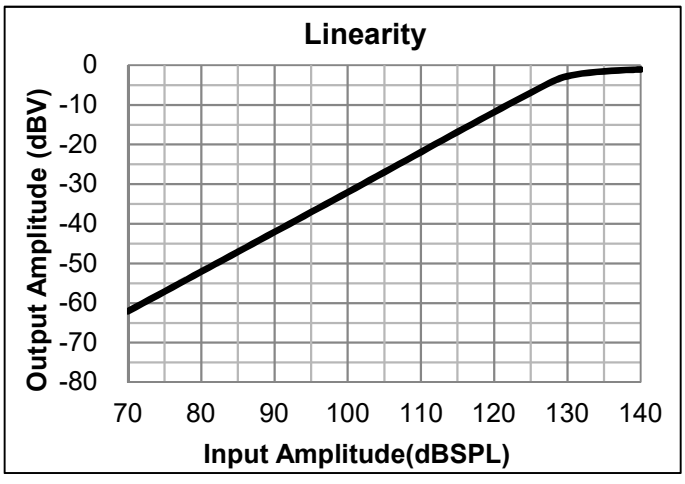


Fig. 6 Linearity

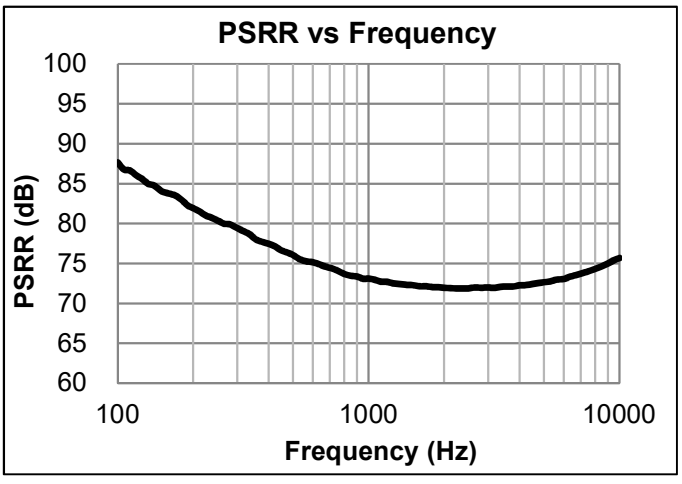


Fig. 7 Typical PSRR curve

Measurement System Setup

Test signal: Sinusoid, Sweep,

Step: 1/12 octave

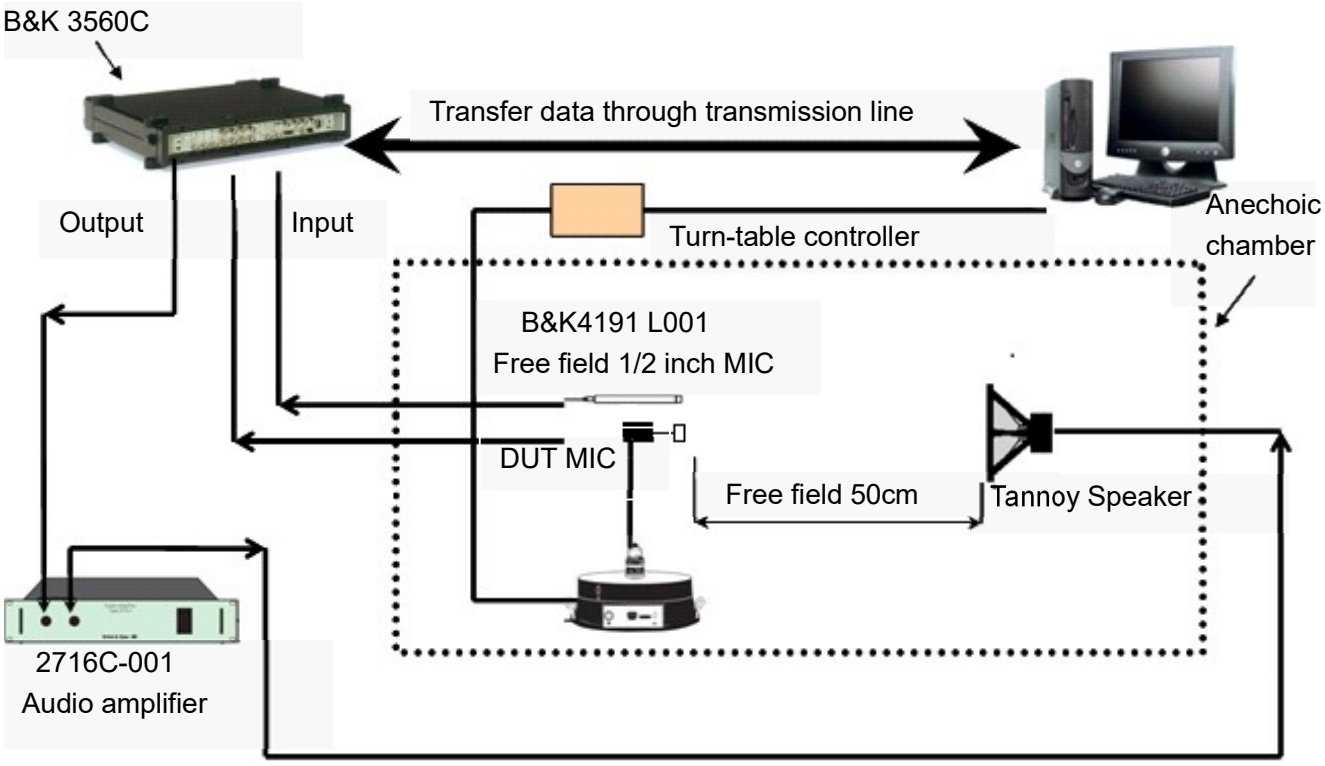


Fig. 8 Measurement System Setup

Typical Application Circuit

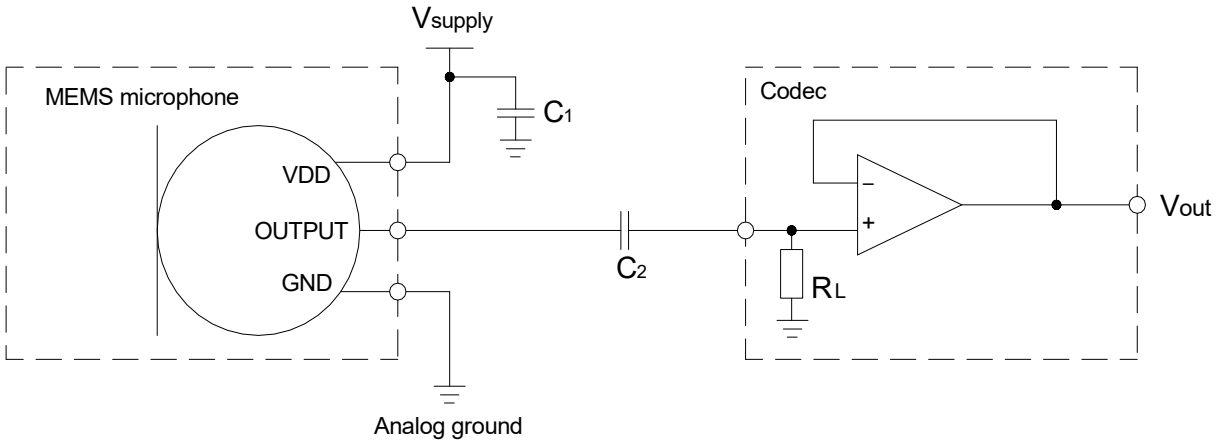


Fig. 9 Typical Application Circuit

Power supply decoupling:

A 0.1uF ceramic type decoupling capacitor C_1 is strongly recommended for every microphone and it should be placed as close to the VDD pad to reduce the noise on power supply;
The trace connected to each pad of capacitor should be as short as possible, and should stay on one layer of PCB without via. For the best performance, recommend to place the capacitor equidistance from power and ground pins of microphone, or slightly closer to the power pin if space not allowed. System ground should connect to far side of the capacitor, as shown in fig.10.

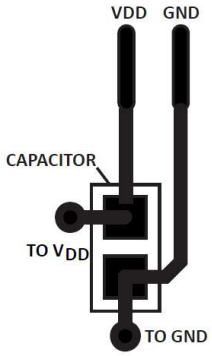


Fig. 10 Recommended Power Supply Decoupling Capacitor Layout

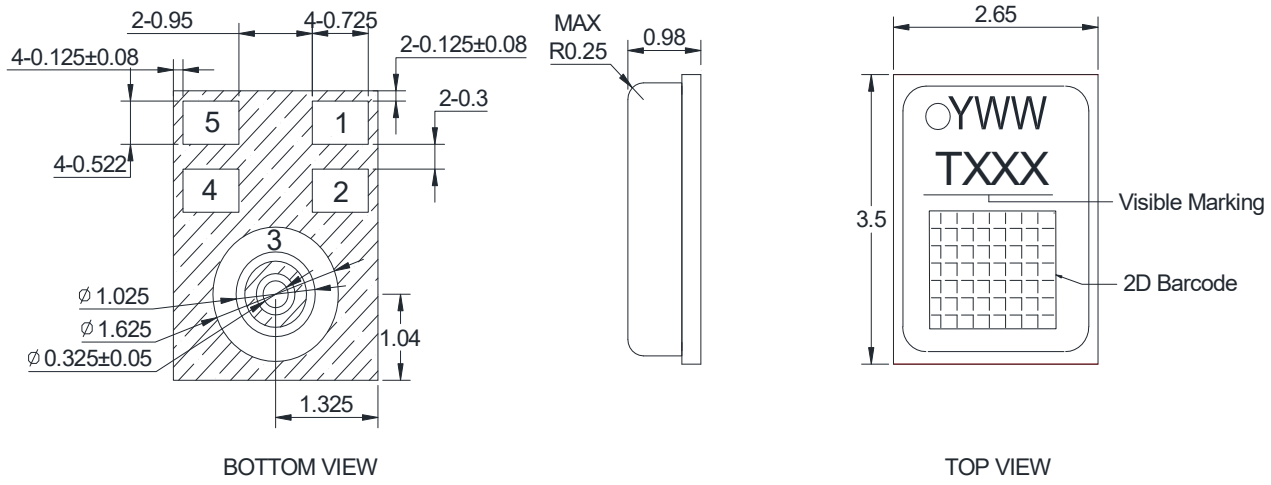
Low frequency roll-off:

DC-blocking capacitor C_2 is required on the output signal line. The 3-dB cut-off frequency can be calculated using follow equation which is related to DC-blocking capacitor C_2 and input resistance of the amplifier.

$$3dB\ cut\text{-}off\ frequency=1/2\pi R_L C_2$$

In order to get a cut-off frequency below 20 Hz, minimum 1uF value of C_2 and minimum 20KΩ value of input resistance of the amplifier is recommended.

Mechanical Specifications



Unit：mm　Unmarked Tolerance: ± 0.1 (mm)

Fig. 13 Dimension

Item	Dimension	Tolerance
Length	3.50	±0.1
Width	2.65	±0.1
Height	0.98	±0.1
Acoustic Port	0.325	±0.05

PIN	Definition	Description
1	OUT	Output
2	GND	Ground
3	GND	Ground
4	GND	Ground
5	VDD	Power Supply

Note:

- All Ground Pin must be connected to the ground in end application
- Identification Marking

  ○: Polarity sign　Y: Year　WW: Week

  T: GETTOP　XXX: Serial Number

  2D Barcode

Reliability Specifications

After conducting any of the following tests, the sensitivity change of DUT shall be less than ±3dB from its initial value unless otherwise noted, and shall keep its initial operation and appearance.

Table 3 Reliability Specifications

No.	Item	Test condition
1	Hi-Temperature Test	Temperature:+85℃ Duration: 240 hours
2	Low-Temperature Test	Temperature:-40℃ Duration: 240 hours
3	Humidity & Heat operating Test	Temperature: +70℃ Humidity: 93% RH Duration: 240 hours
4	Thermal Shocking Test	Temperature & Duration: -40℃, 30 minutes Temperature & Duration: +80℃, 30 minutes, Cycles: 32 cycles
5	Vibration Test	Frequency:10-55Hz Amplitude: 1.52mm Direction: 2 directions Duration: 2 hours
6	Drop Test	Drop the microphones to the floor without package. Height:1.5m Reference Surface: slippery marble floor Duration: 5 times
7	Electrostatic Discharge	The tests are performed acc. to IEC61000-4-2 level 2: a. Contact Discharge Discharge Position: Output of Microphone Charge Voltage: ±4000VDC Discharge Network: 150pF & 330Ω b. Air Discharge Discharge Position: Sound Hole Charge Voltage:±4000VDC Discharge Network: 150pF & 330Ω

Packaging Details

* Use ESD reel and tape for microphone packaging.

* Anti-static measures should be applied during packaging operation.

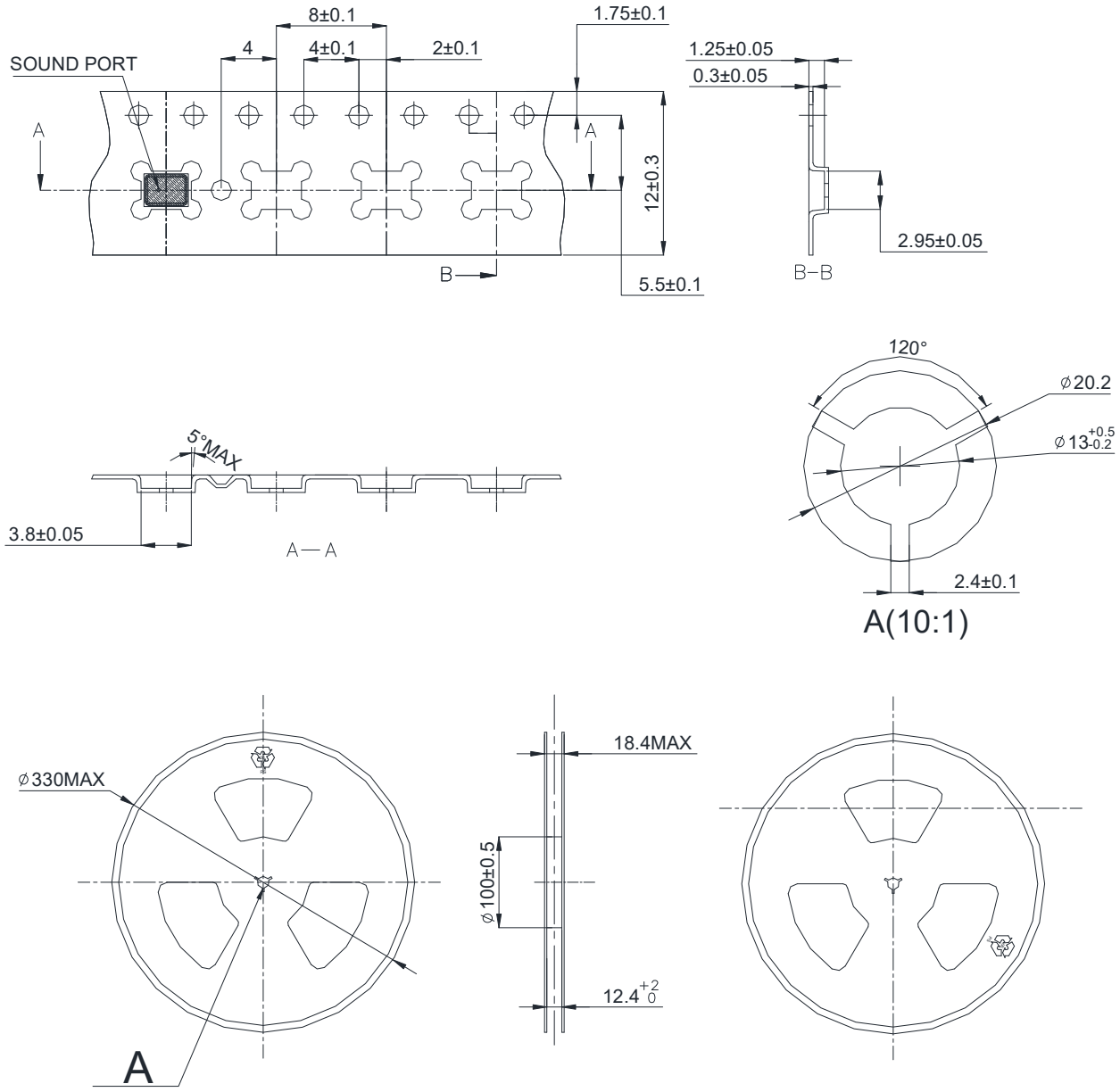
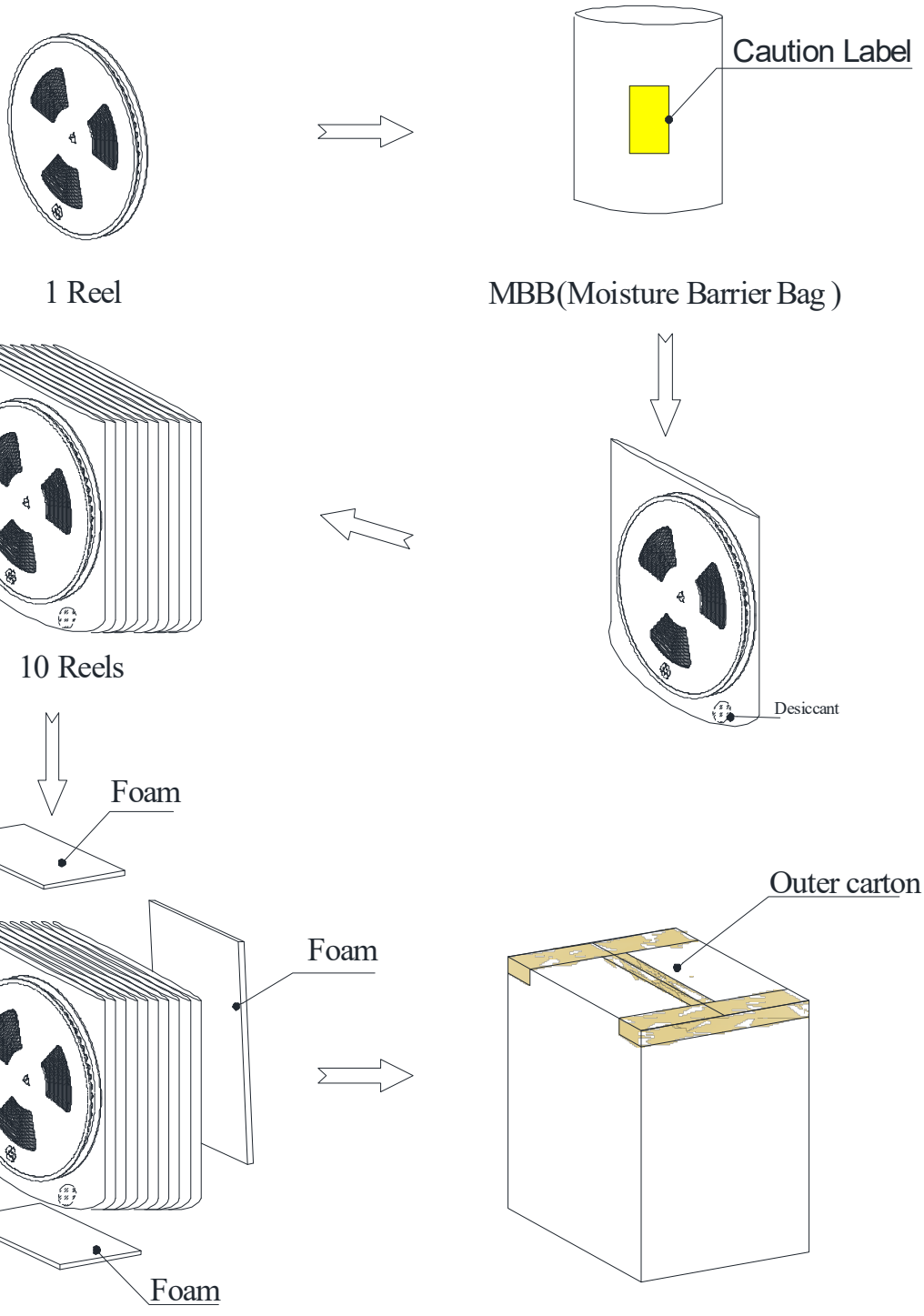


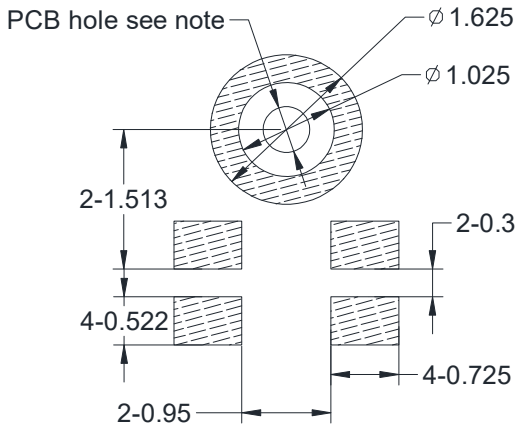
Fig. 12 Packaging



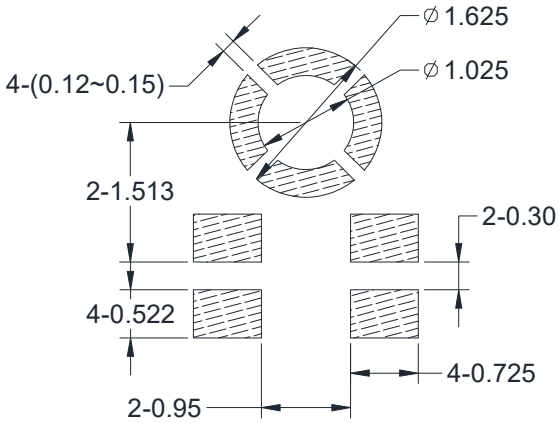
Tape and Reel	φ330mm	5,500PCS×1=5,500PCS
Shipping Box	215mm*370mm*370mm	5,500PCS×10=55,000PCS

Application Design Suggestions

Recommended PCB and Stencil Design Pattern



Example Land Pattern



Example Solder Stencil Pattern

Notes:

- Dimensions are in millimeters unless otherwise specified.
- Tolerance is ±0.1mm unless otherwise specified.
- The recommended non-plated hole diameter of PCB is 0.4-0.8mm.

Temperature Profile during Reflow Process

Table 4 Temperature Profile during Reflow Process

Parameter		Reference	Specification
Average Ramp Rate		T_L to T_P	3°C/sec max
Preheat	Minimum Temperature	T_{SMIN}	150°C
	Maximum Temperature	T_{SMAX}	200°C
	Time T_{SMIN} to T_{SMAX}	t_S	60 sec to 180 sec
Ramp-Up Rate		T_{SMAX} to T_L	1.25°C/sec
Time Maintained Above Liquidous		t_L	60 sec to 150 sec
Liquidous Temperature		T_L	217°C
Peak Temperature		T_P	260°C
Time Within +5°C of Actual Peak Temperature		t_P	20 sec to 40 sec
Ramp-Down Rate		T_P to T_{SMAX}	6°C/sec max
Time +25°C (t25°C) to Peak Temperature			8 min max

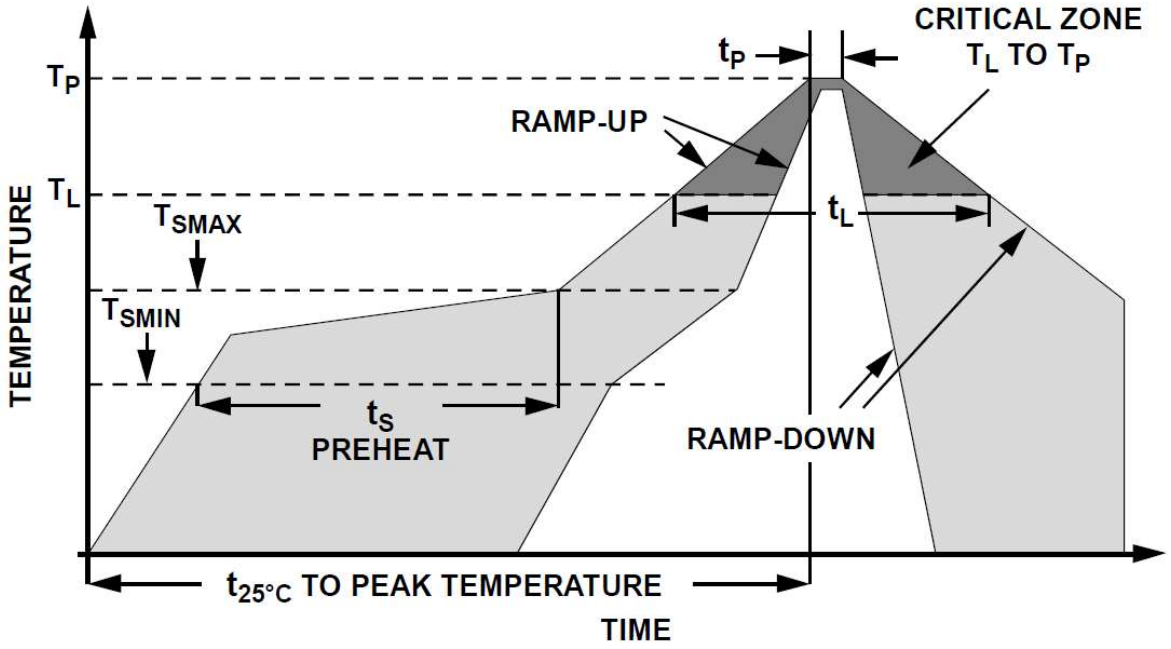


Fig. 13 Reflow Profile

Additional Notes：

- After the initial reflow, the MIC shall be resumed to room temperature if more reflow is needed.
- No more than 3 times reflow is recommended.
- Do not board wash by liquid or ultrasonic after the reflow process.
- Do not pull a vacuum over port hole of the microphone.
- Do not insert any object in port hole of device at any time.
- Suggest SMT the microphone at last time if double side PCBA used.
- Do not seal sound port during reflow .
- If there is any leakage risk, the peak temperature should be set to less than 240°C or more than 255°C.

Recommended nozzle for reflow MIC

External diameter is Φ1.8mm
Inside diameter is Φ1.2mm

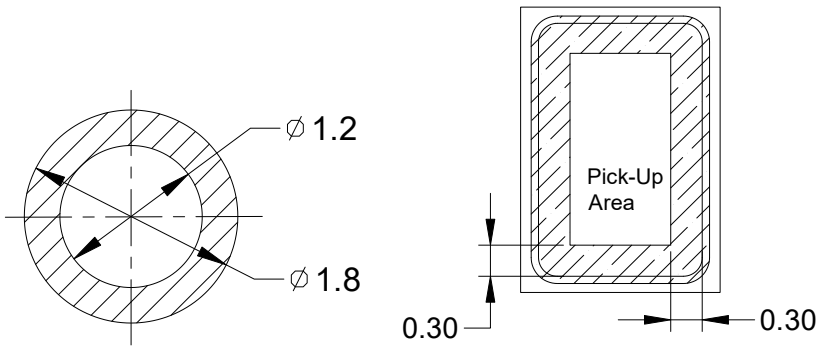


Fig. 14 Recommended nozzle for reflow MIC and Pick-up Area

Special Cautions

Air Rifle Cleaning Restriction

Do not bring air rifle to the port hole directly.
Recommended Condition:
Air pressure < 0.3MPa;
Distance>5cm;
Time<5 sec

Package

Do not store the remained material with the vacuum seal static bags.

Storage

The component needs to meet the requirement of MSL(Moisture Sensitivity Level) class 1.
Please keep MICs in warehouse with humidity less than 75% and without sudden temperature change, acid air, and any other harmful air or strong magnetic field.
Please protect products against moist, shock, sunburn and pressure.
Please take proper measures against ESD in the process of assembly and transportation.
Please use the shipping package for long-term storage.

Notes: More application suggestions can be found in the latest "MEMS Microphone Application Notes".

Specification Revisions

Date	Version	Description
09-22-2023	V1.0	Initial release
08-19-2024	V2.0	Updated Output load description
10-11-2024	V3.0	Updated Reliability Specifications and metal cap
12-23-2024	V4.0	Updated 2D and marking information
07-31-2025	V5.0	Updated Gettop information

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